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IEEE ICMA 2009

2009 IEEE International Conference on Mechatronics and Automation

August 9 - 12, 2009**Changchun, Jilin, China****Co-sponsors: IEEE Robotics and Automation Society, CUST and Kagawa University****Technical Co-sponsors: NSFC, CAA, CMES, RSJ, JSME, SICE, JSPE, HEU, UEC, UESTC, BUT, JLU, HIT**

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The 2009 IEEE International Conference on Mechatronics and Automation (ICMA 2009) will take place in Changchun, Jilin, China from August 9 to August 12, 2009. A renowned ancient city in China, Changchun is situated in northeastern China. As the capital of Jilin province, Changchun is known as the cradle of new China's automobile industry, optoelectronics technology and biological technology, applied chemistry and so on. It ranks predominantly China in terms of the research and development on optics, exactitude apparatus, laser technique, macromolecule material, biological products, super conduct and automobile, etc.

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